Electronic Patent Application Fee Transmittal							
Application Number:	10510848						
Filing Date:	13-Oct-2004						
Title of Invention:	Dia	Diamond composite substrate and process for producing the same					
First Named Inventor/Applicant Name:	Kiichi Meguro						
Filer:	Michael E. Fogarty/3328/Matilda Mason						
Attorney Docket Number:	50389-053						
Filed as Large Entity							
U.S. National Stage under 35 USC 371 Filing	Fee	s					
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							
Extension - 1 month with \$0 paid		1251	1	130	130		

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)				
Miscellaneous:								
Request for continued examination	1801	1	810	810				
	Tot	940						